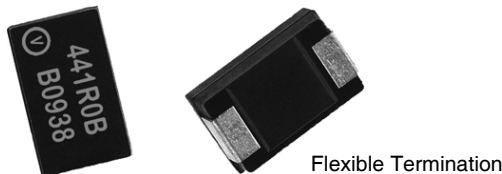


**Ultra High Precision Industrial Grade with the Second Generation of Z-Foil (Z1-Foil)
Molded Surface Mount Resistor with TCR down to $\pm 0.5 \text{ ppm}/^\circ\text{C}$ Maximum, PCR of $\pm 5 \text{ ppm}$
at Rated Power, Flexible Terminations, and Load Life Stability of $\pm 0.005 \%$ (50 ppm)**



Flexible Termination

INTRODUCTION

Flexible Terminations with Zero TCR

The SMR3P flexible termination resistor with the second generation of Z-Foil (Z1-Foil) features new orders of accuracy, stability and speed in a size small enough for permanent assembly in operational equipment.

It is well known that chips of 1206 and larger dimensions occasionally delaminate from the printed circuit board or develop cracks. This is due to stresses introduced into the chip by handling of the PC board and stress due to thermal shock.

Vishay Foil Resistors (VFR) has introduced a chip in a molded package with flexible terminations which does not change due to the above, i.e. no cracks and no separation from the board.

The SMR3P is the industry's lowest absolute TCR, thus reducing a major source of uncertainty in precision circuits. The SMR3P can withstand unconventional environmental conditions, including the extremely high temperatures and radiation-rich environments of down-hole oil exploration and well logging, or the deep-sea underwater repeaters in cross-ocean communications. The exceptionally-low TCR of the new Z-Foil Bulk Metal® Foil resistor derives from an elegant balance of metallurgical resistivity and temperature-induced compressive force.

The SMR3P comes with a Load Life Stability certificate:

The Bulk Metal Z-Foil resistor has documented the most precise load-life stability of any resistor. That's because the resistance element is a Bulk Metal Z-alloy that has been applied to a substrate with a unique formation of a resistive pattern that is maintained stress-free through the balance of the process, including termination welding, encapsulation, marking, curing, etc. Coatings between the element and the external case isolate the element from external stresses. The flat planar foil very efficiently transmits heat to the substrate and dissipates it through the leads and through the package body. The SMR series of surface-mounts has the further advantage of flexible terminations to isolate the element from repetitive expansions and contractions of the board, thereby assuring even better long-term stability. Moreover, all VFR Bulk Metal Foil resistors are rated to maintain rated stability at full rated power and temperature. So it is not necessary to de-rate the foil resistors in application.

Application includes:

1. Secondary standards
2. Feedback devices for operational amplifiers
3. Precision voltage dividers
4. Precision bridge resistors
5. Decade voltage dividers

Our application engineering department is available to advise and make recommendations. For non-standard technical requirements and special applications, please contact us.

FEATURES

- Temperature coefficient of resistance (TCR): $\pm 0.5 \text{ ppm}/^\circ\text{C}$ maximum (+ 25 °C to + 125 °C)
- Tolerance: to $\pm 0.01 \%$
- Power coefficient of resistance (PCR) "ΔR due to self heating": 5 ppm at rated power
- Flexible terminations ensure minimal stress transference from the PCB due to load induced temperature gradients and a difference in thermal coefficient of expansions (TCE)
- Electrostatic discharge (ESD) up to 25 000 V
- Load life stability: $\pm 0.005 \%$ (70 °C, 2000 h at rated power)
- Resistance range: 100 Ω to 15 kΩ
- Vishay Foil resistors are not restricted to standard values; specific "as-required" values can be supplied at no extra cost or delivery (e.g. 1K0002 vs. 1K)
- Power rating: to 600 mW at 70 °C
- Non-inductive, non-capacitive design
- Current noise: 0.010 μV_{RMS}/V of applied voltage (< - 40 dB)
- Voltage coefficient: < 0.1 ppm/V
- Non-inductive: < 0.08 μH typical
- Thermal stabilization time < 1 s (nominal value achieved within 10 ppm of steady state value)
- Pattern design minimizing hot spots
- Terminal finish: lead (Pb)-free or tin/lead alloy
- Matched sets with TCR tracking are available upon request
- For better performances please contact us
- Prototype quantities available in just 5 working days or sooner. For more information, please contact foil@vishaypg.com
- Compliant to RoHS directive 2002/95/EC



RoHS*
COMPLIANT

APPLICATIONS

- Precision amplifiers
- High precision instrumentation
- Medical
- Automatic test equipment (ATE)
- Industrial
- Audio (high end stereo equipment)
- EB application
- Pulse application
- Measurement instrumentation

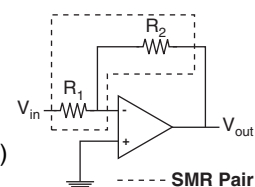


TABLE 1 - TOLERANCE AND TCR VS. RESISTANCE VALUE (1)

VALUE	TIGHTEST TOLERANCE	MAXIMUM TCR (ppm/°C) (+ 25 °C to + 125 °C)	MAXIMUM TCR (ppm/°C) (- 55 °C to + 25 °C)
100 Ω to 15 kΩ	$\pm 0.01 \%$	± 0.5	± 2

Note

(1) Tighter performances are available

* Pb containing terminations are not RoHS compliant, exemptions may apply

FIGURE 1 - POWER DERATING CURVE

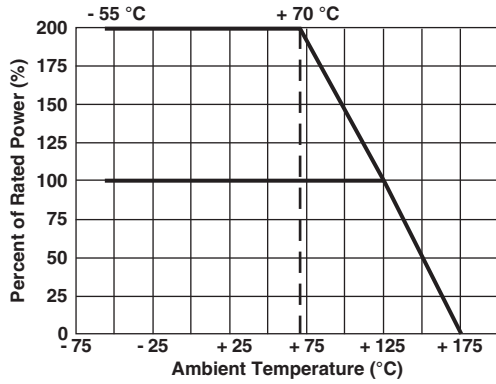
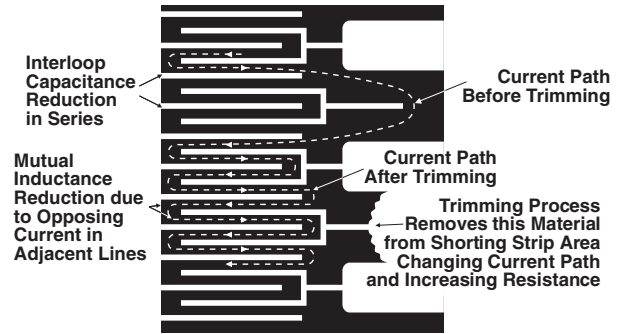
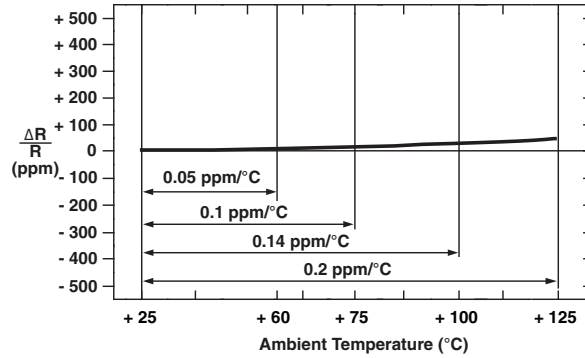


FIGURE 2 - TRIMMING TO VALUES
(conceptual illustration)



Note: Foil shown in black, etched spaces in white

FIGURE 3 - TYPICAL TCR CURVE Z-FOIL

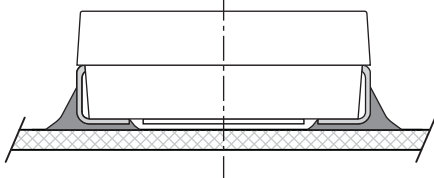


Note

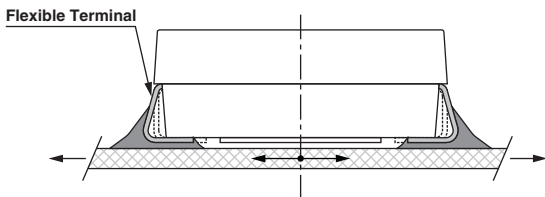
- For more details, see table 1

FIGURE 4 - THERMAL EXPANSION

VFR Bulk Metal Foil SMR Resistor

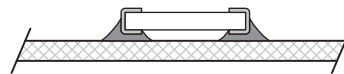


Before Thermal Expansion of PCB

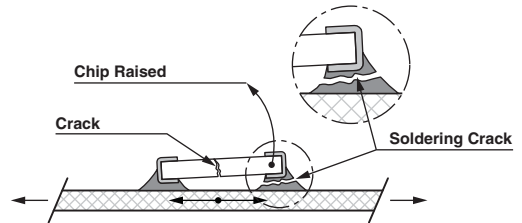


After Thermal Expansion of PCB - ΔT

Wrap Around Metal Film



Before Thermal Expansion of PCB



After Thermal Expansion of PCB - ΔT

TABLE 2 - SMR3P PERFORMANCE SPECIFICATIONS

TEST	CONDITIONS	MAXIMUM LIMIT ⁽¹⁾
Resistance Range		100 Ω to 15 kΩ
Rated Power	100 Ω to 15 kΩ; 0.6 W at 70 °C; 0.3 W at 125 °C	See figure 1
Maximum Working Voltage		180 V
Maximum Operating Temperature	+ 175 °C (see figure 1)	
Working Temperature Range	- 55 °C to + 125 °C (MIL range)	
Thermal Shock	- 65 °C to + 150 °C; 30 min; 5 cycles	± 0.01 % (100 ppm)
Short Time Overload	6.25 x rated power; 5 s	± 0.01 % (100 ppm)
Low Temperature Storage	- 65 °C, 24 h	± 0.01 % (100 ppm)
Low Temperature Operation	45 min at rated power at - 65 °C	± 0.01 % (100 ppm)
Dielectric Withstanding Voltage (DWV)	Atmospheric pressure; AC 200 V; 1 min	± 0.01 % (100 ppm)
Insulation Resistance (MΩ)	DC 100 V; 1 min	over 10 000
Resistance to Soldering Heat (%)	260 °C; 10 sec	± 0.02 % max., ± 0.01 % typ.
Moisture Resistance	+ 65 °C to - 10 °C; 90 % to 98 % RH; rated power; 240 h	± 0.02 % (200 ppm)
Shock	100 G; sawtooth at 6 ms	± 0.01 % (100 ppm)
Vibration, High Frequency	10 Hz to 2000 Hz to 10 Hz; 20 G	± 0.01 % (100 ppm)
Load Life Stability (2000 h)	0.15 W at + 70 °C 0.6 W at + 70 °C 0.3 W at + 125 °C	± 0.002 % typ., ± 0.01 % max. ± 0.005 % typ., ± 0.015 % max. ± 0.005 % typ., ± 0.015 % max.
Load Life Stability (10 000 h)		± 0.005 % typ., ± 0.015 % max. ± 0.015 % typ., ± 0.05 % max. ± 0.015 % typ., ± 0.05 % max.
High Temperature Exposure	175 °C; no load 2000 h	± 0.05 % (500 ppm)
Weight		0.244 g
Packaging	Bulk (loose) or tape and reel, per EIA-481-1	

Note

(1) As shown + 0.01 Ω to allow for measurement error at low values

FIGURE 5 - DIMENSIONS in inches (millimeters)

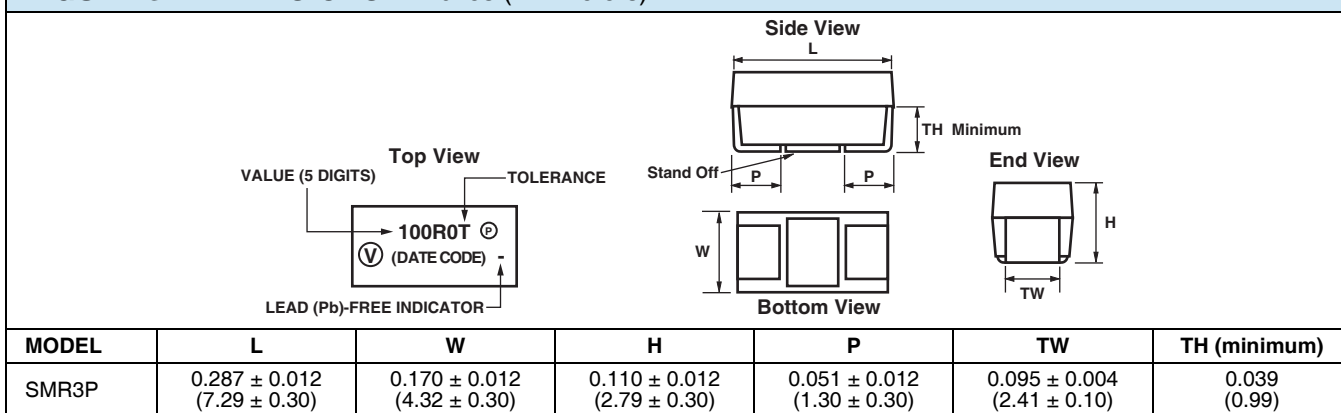


FIGURE 6 - RECOMMENDED MOUNTING PAD GEOMETRIES in inches (millimeters)

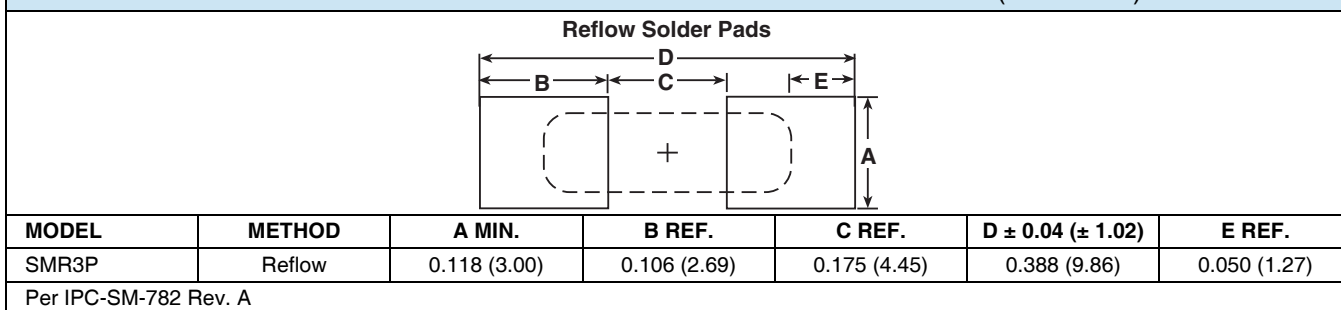
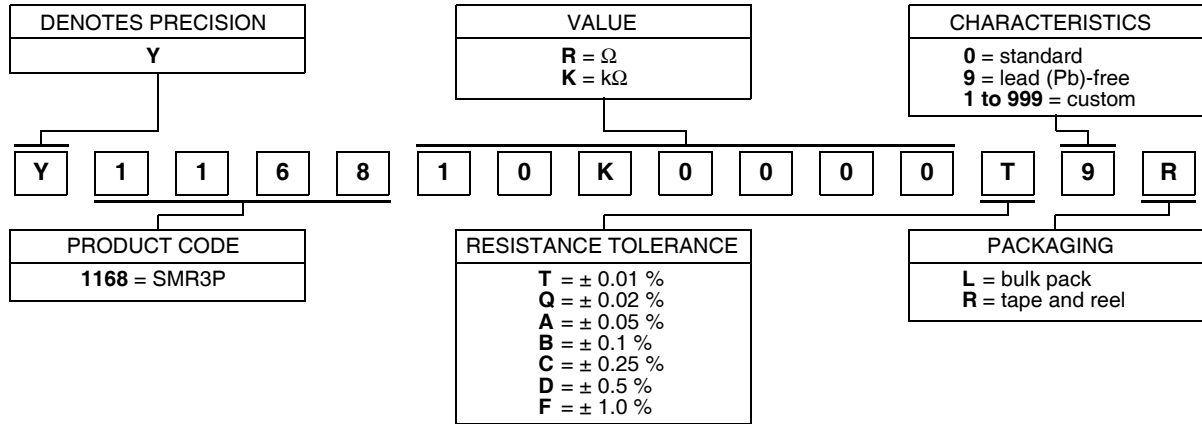


TABLE 3 - GLOBAL PART NUMBER INFORMATION (1)

NEW GLOBAL PART NUMBER: Y116810K0000T9R (preferred part number format)



FOR EXAMPLE: ABOVE GLOBAL ORDER Y1168 10K0000 T 9 R:

TYPE: SMR3P

VALUE: 10.0 $k\Omega$

ABSOLUTE TOLERANCE: $\pm 0.01\%$

TERMINATION: Lead (Pb)-free

PACKAGING: Tape and reel

HISTORICAL PART NUMBER: SMR3P 10K000 TCR0.2 T S T (will continue to be used)

SMR3P	10K000	TCR0.2	T	S	T
MODEL	OHMIC VALUE	TCR CHARACTERISTIC	RESISTANCE TOLERANCE	TERMINATION	PACKAGING
SMR3P	10.0 $k\Omega$		T = $\pm 0.01\%$ Q = $\pm 0.02\%$ A = $\pm 0.05\%$ B = $\pm 0.1\%$ C = $\pm 0.25\%$ D = $\pm 0.5\%$ F = $\pm 1.0\%$	S = lead (Pb)-free B = tin/lead	B = bulk pack T = tape and reel

Note

(1) For non-standard requests, please contact application engineering.